

## → ThinkSystem SR550 technical specifications

Product technical specifications

## **Technical specifications**

The table shows SR550 detailed specifications.

SR550	Descriptions
Processor	Next-generation Intel® Xeon® processor product family (Skylake)  Up to 125 W (Platinum, Gold, Sliver, Bronze)
Memory	Six channels per CPU     12x DDR4 (RDIMM/LRDIMM) 2666 MHz DIMMs     Supports 8 GB / 16 GB / 32 GB / 64 GB DIMMs     Up to 768 GB
Drive bay	<ul> <li>Up to eight 3.5-inch simple-swap</li> <li>Up to 12x 3.5-inch hot-swap support</li> <li>Up to 16x 2.5-inch hot-swap support</li> <li>Up to 16x no backplane chassis</li> <li>Up to two M.2 internal (dual M.2 with mirroring)</li> </ul>
RAID and storage HBA	Intel Software RAID     12 Gb RAID support     RAID controllers with eight or 16 ports     Non-RAID HBA with eight or 16 ports

SR550	Descriptions
Networking	<ul> <li>Embedded 2x 1GbE</li> <li>Embedded selectable LOM module up to two ports</li> <li>ML2 available</li> <li>1 GbE dedicated management port</li> </ul>
PCle	Up to six PCle 3.0 slots
Power supply	<ul> <li>550 W / 750 W Platinum; 750 W Titanium</li> <li>240 V HVDC Ready (PRC only)</li> <li>Energy Star 2.1 Compliance</li> </ul>
System management	Lenovo XClarity System Management     Administrator / Pro / Integrators     Controller Standard / Advanced / Enterprise     Energy Manager
Thermal and cooling	ASHRAE A4 with limitations     Non-hot-swappable redundant fans